

### **MOSFET**

## OptiMOS™ 6 Power-Transistor, 200 V

### **Features**

- N-channel, normal level
- Low on-resistance R<sub>DS(on)</sub>
   Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
   Very low reverse recovery charge (Q<sub>rr</sub>)
- 175°C operating temperature
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- 100% avalanche tested

### **Product validation**

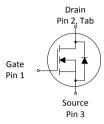
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key performance parameters

Parameter	Value	Unit
$V_{\mathrm{DS}}$	200	V
R <sub>DS(on),max</sub>	13	mΩ
I <sub>D</sub>	87	А
$Q_{ m oss}$	116	nC
$Q_{G}$	37	nC
Q <sub>rr</sub> (1000A/μ)	271	nC









Part number	Package	Marking	Related links
IPP130N20NM6	PG-TO220-3	130N20N6	-

## Public

# OptiMOS™ 6 Power-Transistor, 200 V IPP130N20NM6



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# OptiMOS™ 6 Power-Transistor, 200 V IPP130N20NM6



## 1 Maximum ratings

at  $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamakav	Symbol	Values			l lmit	Note / Test condition	
Parameter	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition	
		-	-	87		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C	
<b>2</b> (1)	<b>,</b>			62	_	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C	
Continuous drain current 1)	$I_{D}$			64	Α	$V_{\rm GS}$ =15 V, $T_{\rm C}$ =100 °C	
				11		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	348	Α	<i>T</i> <sub>A</sub> =25 °C	
Avalanche energy, single pulse 4)	E <sub>AS</sub>	-	-	258	mJ	$I_{\rm D}$ =39 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	$V_{GS}$	-20	-	20	V	-	
Daniel discipation	$P_{\rm tot}$			234	14/	<i>T</i> <sub>c</sub> =25 °C	
Power dissipation		-	-	3.8	W	$T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W <sup>2)</sup>	
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	-	

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

## 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
raiailletei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition
Thermal resistance, junction - case	$R_{thJC}$		0.51	0.64		
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>5)</sup>	$R_{thJA}$	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	$R_{ m thJA}$		-	62		

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS™ 6 Power-Transistor, 200 V IPP130N20NM6



## 3 Electrical characteristics

at  $T_i$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			l lmit	Note / Test condition	
raiailletei	Symbol	Min.	Тур.	Max.		Note / Test condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	200	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.7	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 129 \mu \text{A}$	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1	1	μΑ	$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	
			10	100	μΑ	$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	$I_{GSS}$	-	10	100	nA	$V_{GS}$ =20 V, $V_{DS}$ =0 V	
Drain-source on-state resistance	0	-	10.0	12.0	mΩ	$V_{\rm GS}$ =15 V, $I_{\rm D}$ =65 A	
Diain-source on-state resistance	$R_{DS(on)}$		11.5	13.0	11122	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =65 A	
Gate resistance	R <sub>G</sub>	-	3.2	-	Ω	-	
Transconductance <sup>6)</sup>	$g_{fs}$	18	36	-	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D}=65 \text{ A}$	

<sup>6)</sup> Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test condition	
raiailletei	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test condition	
Input capacitance	C <sub>iss</sub>		2900	3800			
Output capacitance <sup>7)</sup>	$C_{\rm oss}$	-	460	600	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =100 V, $f$ =1 MHz	
Reverse transfer capacitance <sup>7)</sup>	C <sub>rss</sub>		19	33			
Turn-on delay time	$t_{\sf d(on)}$		12				
Rise time	t <sub>r</sub>	-	13		ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =32.5 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Turn-off delay time	$t_{\sf d(off)}$		20	]			
Fall time	$t_{f}$		7				

 $<sup>^{7)}</sup>$  Defined by design. Not subject to production test.

# OptiMOS™ 6 Power-Transistor, 200 V IPP130N20NM6



Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note / Test condition	
raiailletei	Syllibol	Min.	Тур.	Max.	Oille	Note / Test condition	
Gate to source charge	$Q_{\mathrm{gs}}$		20	-	nC		
Gate charge at threshold	$Q_{\rm g(th)}$		10.7	-	nC		
Gate to drain charge <sup>9)</sup>	$Q_{ m gd}$		7.5	11.3	nC		
Switching charge	$Q_{sw}$	]	16.9	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =32.5 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total <sup>9)</sup>	$Q_{\mathrm{g}}$		37	56	nC		
Gate plateau voltage	$V_{ m plateau}$		6.9	-	V		
Output charge <sup>9)</sup>	$Q_{\rm oss}$	-	116	151	nC	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V	

<sup>8)</sup> See "Gate charge waveforms" for parameter definition

### Table 7 Reverse diode

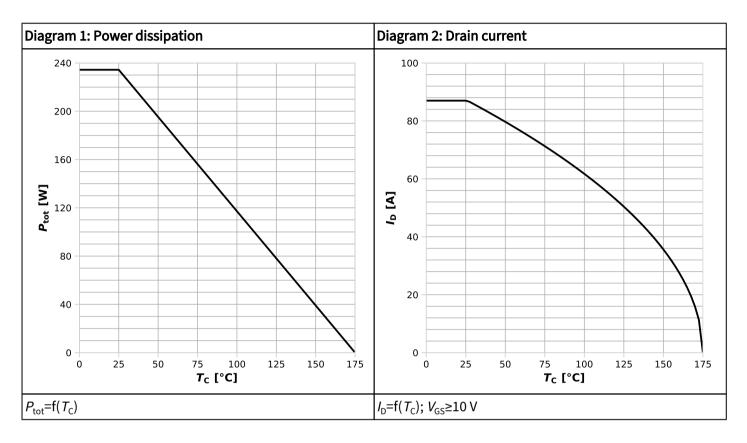
Parameter	Symbol	Values			Unit	Note / Test condition	
Parameter	Syllibot	Min.	Тур.	Max.	Offic	Note / Test condition	
Diode continuous forward current	I <sub>S</sub>			87	А	T −25 °C	
Diode pulse current	I <sub>S,pulse</sub>	_	_	348	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.94	1.0	٧	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =65 A, $T_{\rm j}$ =25 °C	
Reverse recovery time	$t_{\rm rr}$		46	-	ns	$V_{\rm R}$ =100 V, $I_{\rm F}$ =32.5 A, d $i_{\rm F}$ /d $t$ =100 A	
Reverse recovery charge <sup>10)</sup>	$Q_{\rm rr}$	-	43	86	nC	/μs	
Reverse recovery time	$t_{\rm rr}$		30	-	ns	$V_{\rm R}$ =100 V, $I_{\rm F}$ =32.5 A, d $i_{\rm F}$ /d $t$ =1000 A	
Reverse recovery charge <sup>10)</sup>	$Q_{\rm rr}$	-	271	542	nC	/μs	

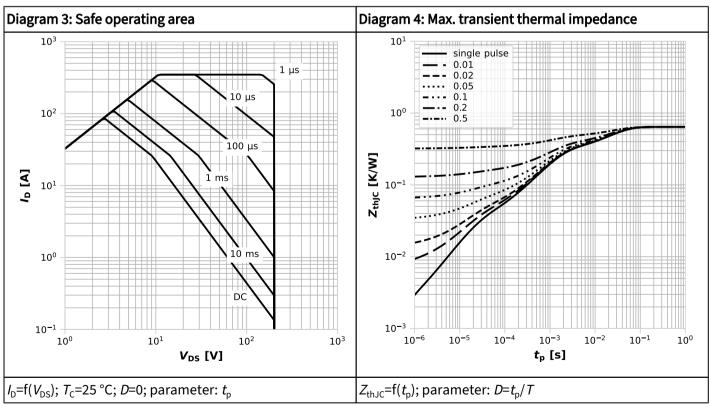
<sup>10)</sup> Defined by design. Not subject to production test.

<sup>9)</sup> Defined by design. Not subject to production test.

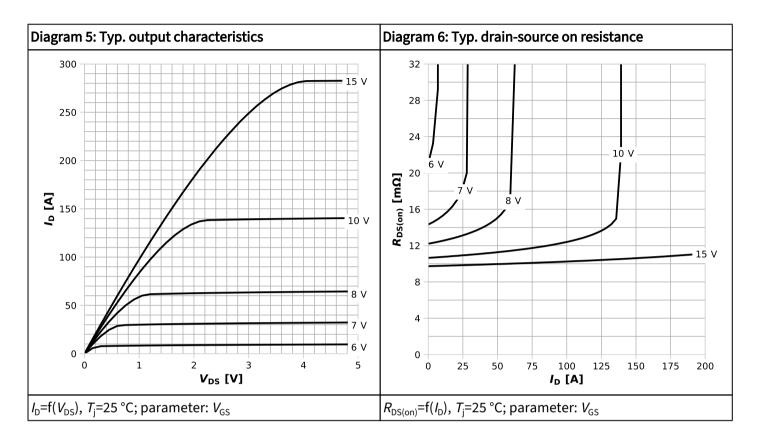


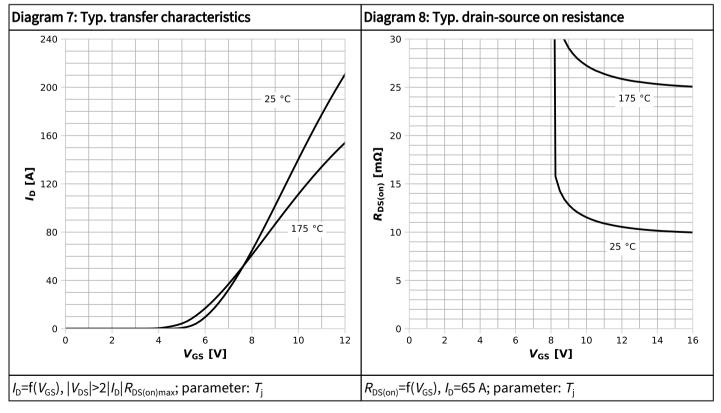
## 4 Electrical characteristics diagrams



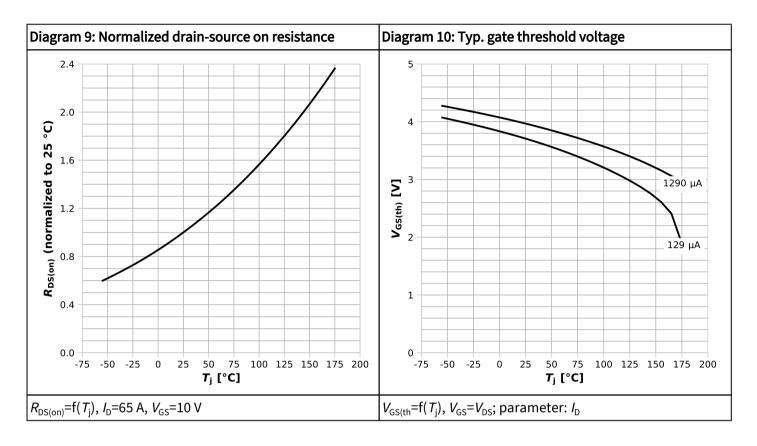


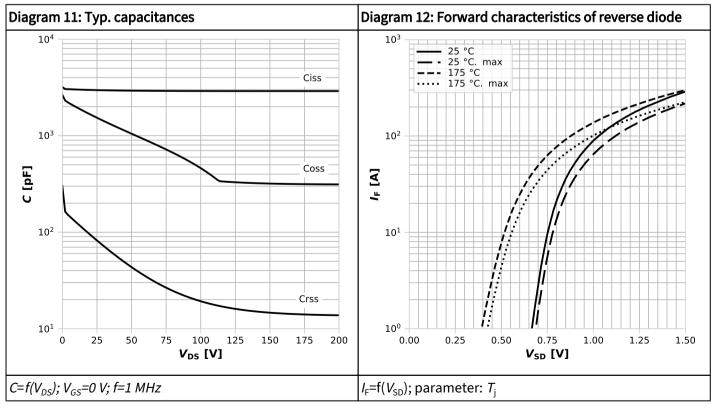




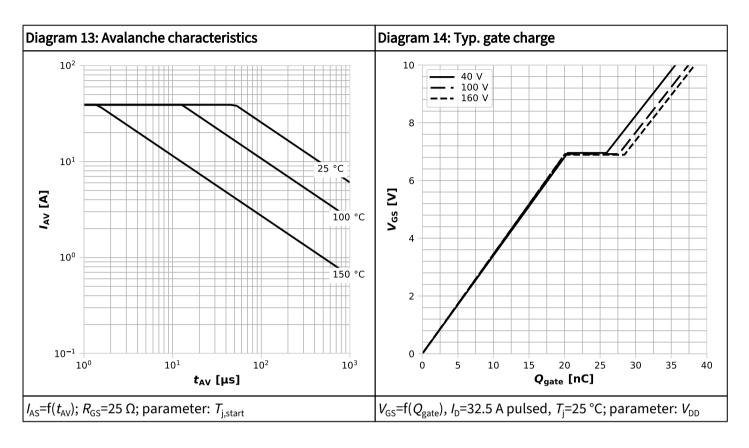


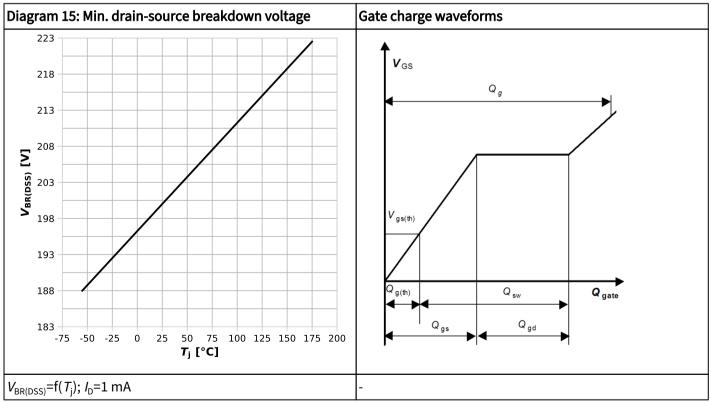














# 5 Package outlines

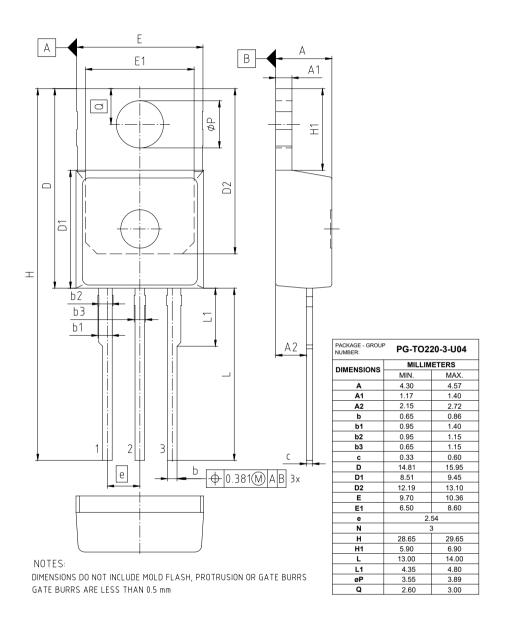


Figure 1 Outline PG-TO220-3, dimensions in mm

## Public

# OptiMOS™ 6 Power-Transistor, 200 V IPP130N20NM6



## **Revision history**

IPP130N20NM6

## Revision 2025-03-27, Rev. 1.0

Previous revisions

Revision	Date	Subjects (major changes since last revision)
1.0	2025-03-27	Release of final datasheet

#### **Public**

# OptiMOS™ 6 Power-Transistor, 200 V IPP130N20NM6



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